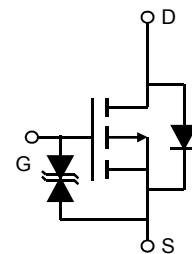


■ Features

- $V_{DS}(V) = -20V$
- $I_D = -5 A$ ($V_{GS} = -4.5V$)
- $R_{DS(ON)} < 43m\Omega$ ($V_{GS} = -4.5V$)
- $R_{DS(ON)} < 55m\Omega$ ($V_{GS} = -2.5V$)
- $R_{DS(ON)} < 75m\Omega$ ($V_{GS} = -1.8V$)
- $R_{DS(ON)} < 100m\Omega$ ($V_{GS} = -1.5V$)

■ Simplified outline(SOT23-3L)



■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	-20	V
Gate-Source Voltage	V_{GS}	± 8	
Continuous Drain Current	I_D	-5	A
		-4	
Pulsed Drain Current	I_{DM}	-30	
Power Dissipation	P_D	1.5	W
		1	
Thermal Resistance.Junction- to-Ambient	R_{thJA}	80	$^\circ C/W$
		100	
Thermal Resistance.Junction- to-Lead	R_{thJL}	52	
Junction Temperature	T_J	150	$^\circ C$
Junction Storage Temperature Range	T_{stg}	-55 to 150	

■ Electrical Characteristics $T_a = 25^\circ\text{C}$

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V_{DSS}	$I_D=-250 \mu\text{A}, V_{GS}=0\text{V}$	-20			V
Zero Gate Voltage Drain Current	I_{DSs}	$V_{DS}=-20\text{V}, V_{GS}=0\text{V}$			-1	μA
		$V_{DS}=-20\text{V}, V_{GS}=0\text{V}, T_J=55^\circ\text{C}$			-5	
Gate-Body leakage current	I_{GSS}	$V_{DS}=0\text{V}, V_{GS}=\pm 8\text{V}$			± 10	μA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250 \mu\text{A}$	-0.3		-0.9	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=-4.5\text{V}, I_D=-4\text{A}$			43	$\text{m}\Omega$
		$V_{GS}=-4.5\text{V}, I_D=-4\text{A}, T_J=125^\circ\text{C}$			59	
		$V_{GS}=-2.5\text{V}, I_D=-4\text{A}$			55	
		$V_{GS}=-1.8\text{V}, I_D=-2\text{A}$			75	
		$V_{GS}=-1.5\text{V}, I_D=-1\text{A}$			100	
On state drain current	$I_{D(ON)}$	$V_{GS}=-4.5\text{V}, V_{DS}=-5\text{V}$	-30			A
Forward Transconductance	g_{FS}	$V_{DS}=-5\text{V}, I_D=-4\text{A}$		20		S
Input Capacitance	C_{iss}	$V_{GS}=0\text{V}, V_{DS}=-10\text{V}, f=1\text{MHz}$	600		905	pF
Output Capacitance	C_{oss}		80		150	
Reverse Transfer Capacitance	C_{rss}		48		115	
Gate resistance	R_g	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$	6		20	Ω
Total Gate Charge	Q_g	$V_{GS}=-4.5\text{V}, V_{DS}=-10\text{V}, I_D=-4\text{A}$	7.4		11	nC
Gate Source Charge	Q_{gs}		0.8		1.2	
Gate Drain Charge	Q_{gd}		1.3		3.1	
Turn-On Delay Time	$t_{d(on)}$	$V_{GS}=-4.5\text{V}, V_{DS}=-10\text{V}, R_L=2.5\Omega, R_{GEN}=3\Omega$		13		ns
Turn-On Rise Time	t_r			9		
Turn-Off Delay Time	$t_{d(off)}$			19		
Turn-Off Fall Time	t_f			29		
Body Diode Reverse Recovery Time	t_{rr}	$I_F=-4\text{A}, dI/dt=100\text{A}/\mu\text{s}$	20		32	nC
Body Diode Reverse Recovery Charge	Q_{rr}		40		62	
Maximum Body-Diode Continuous Current	I_s				-2	A
Diode Forward Voltage	V_{SD}	$I_s=-1\text{A}, V_{GS}=0\text{V}$			-1	V

* The static characteristics in Figures 1 to 6 are obtained using <300us pulses, duty cycle 0.5% max.

■ Typical Characteristics

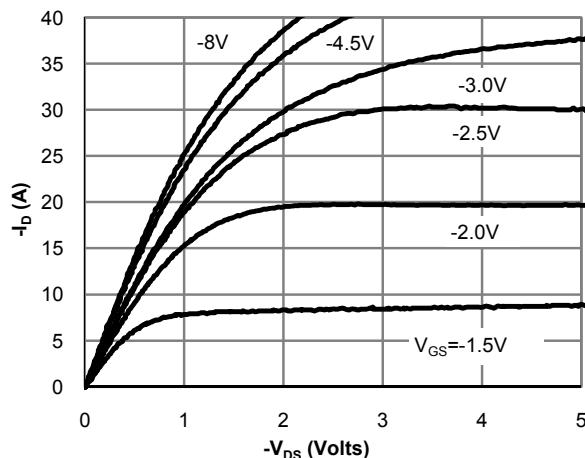


Fig 1: On-Region Characteristics (Note E)

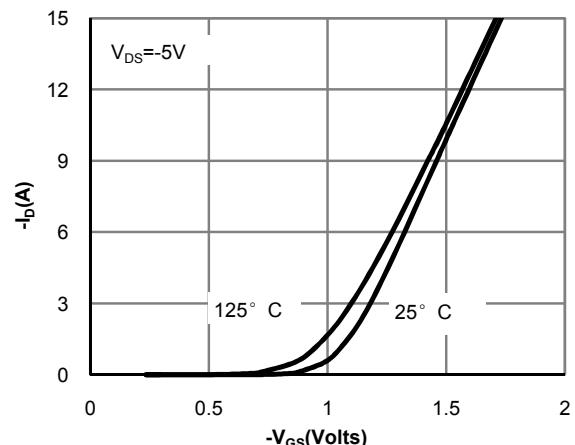


Figure 2: Transfer Characteristics (Note E)

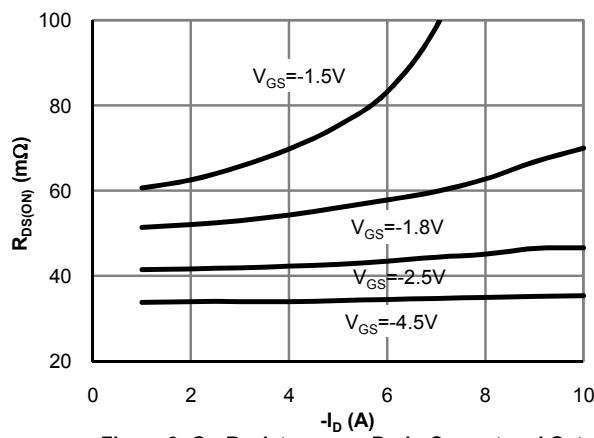


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

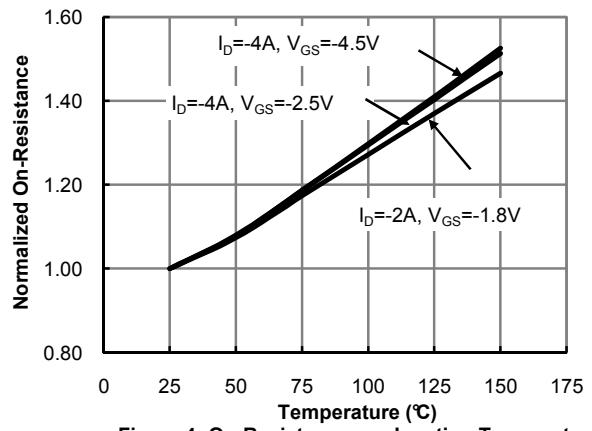


Figure 4: On-Resistance vs. Junction Temperature (Note E)

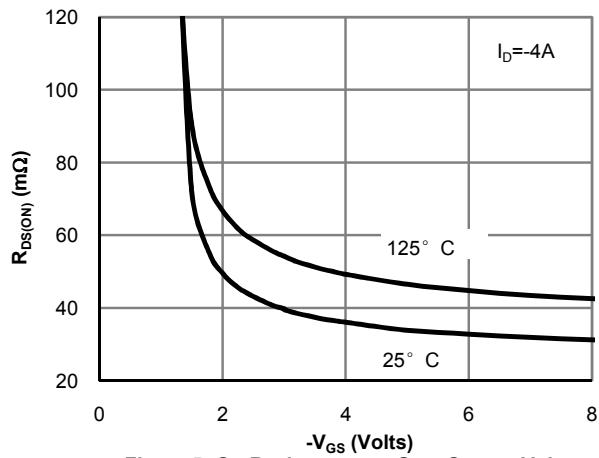


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

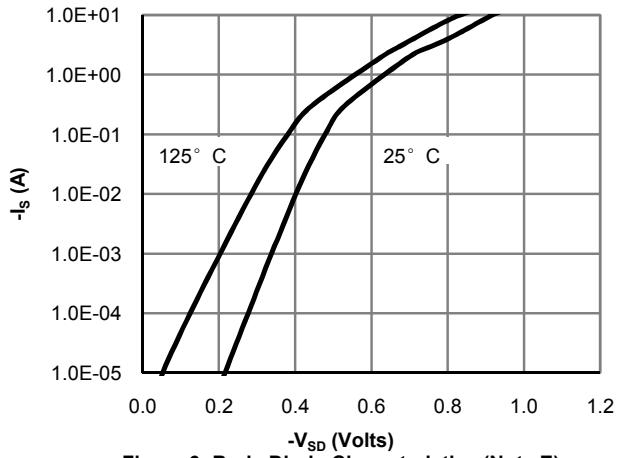
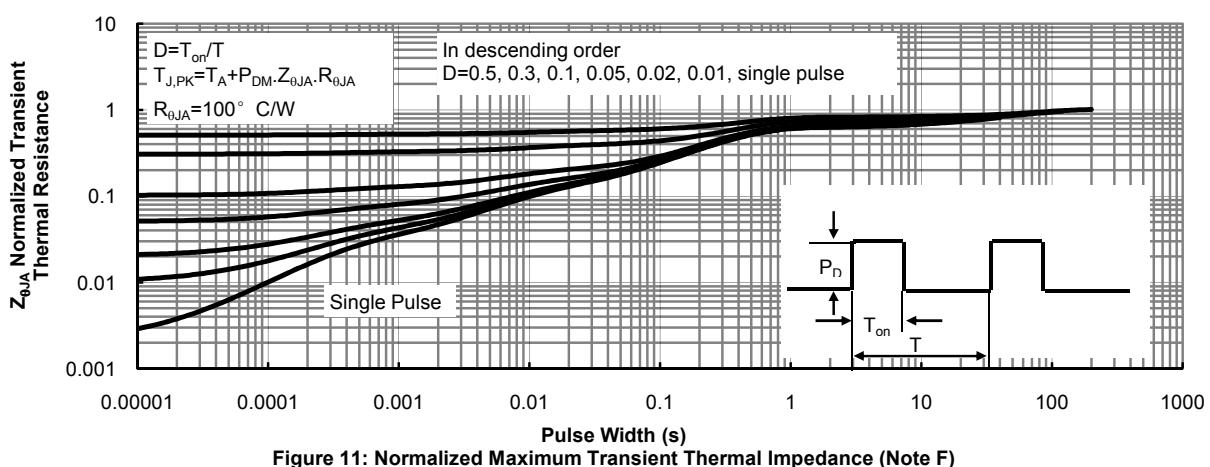
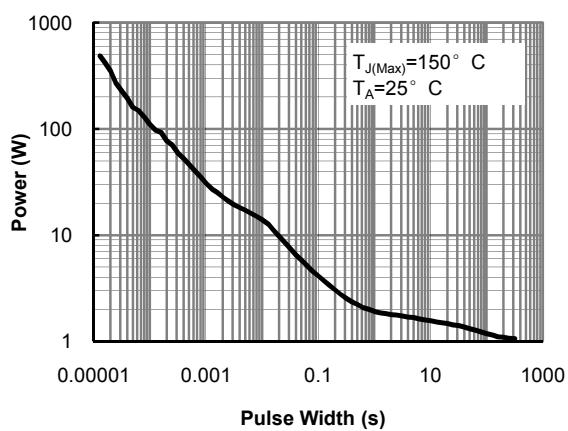
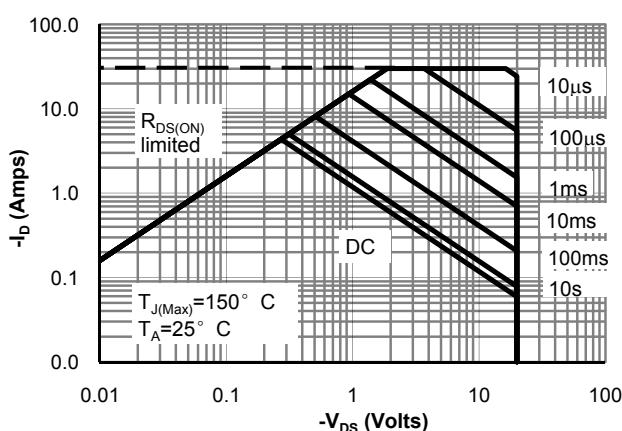
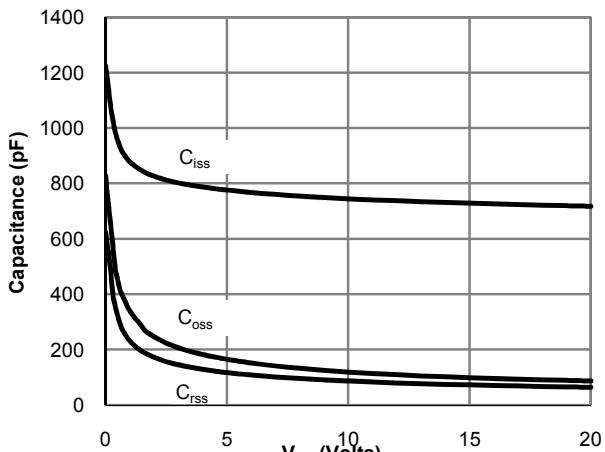
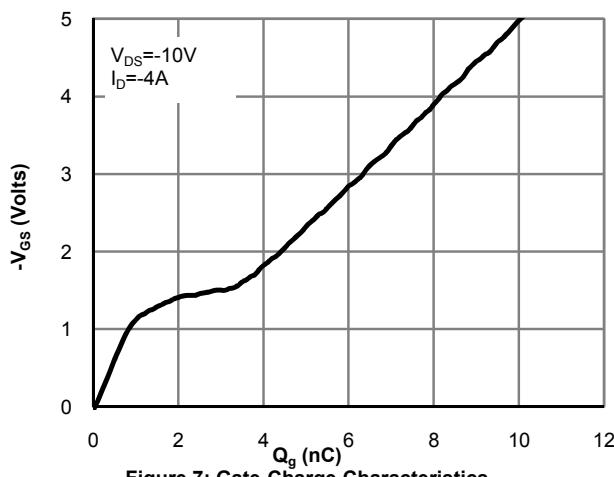
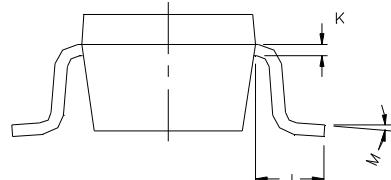
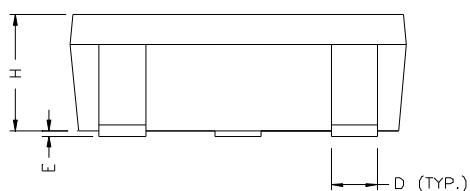
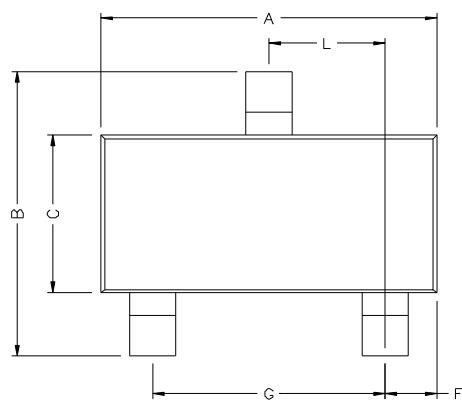


Figure 6: Body-Diode Characteristics (Note E)

■ Typical Characteristics



■ SOT23-3L



DIMENSIONS (mm are the original dimensions)

UNIT	A	B	C	D	E	F	G	H	K	J	L	M
mm	2.70 3.10	2.65 2.95	1.50 1.70	0.35 0.50	0 0.10	0.45 0.55	1.9	1.00 1.30	0.10 0.20	0.40 -	0.85 1.15	0° 10°